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MS#302665.01 (5062)
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of Cohen et al.

Art Unit 2122

Serial No. 10/603,453

Filed 06/25/2003

Confirmation No. 3271

For MULTICAST SYSTEM AND METHOD FOR DEPLOYING MULTIPLE IMAGES
SIMULTANEOUSLY

November 29, 2004

TO THE COMMISSIONER OF PATENTS

SIR:

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

* In accordance with 37 C.F.R. 1.97 and 1.98 and MPEP 609, and in compliance with the duty of disclosure set forth in 37 C.F.R. 1.56, applicants submit the attached PTO/SB/08A for consideration by the Patent and Trademark Office in the above-entitled application and to be made of record therein.

No item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing this certification after making reasonable inquiry, no item of information contained in this Information Disclosure Statement was known to any individual designated in 37 CFR 1.56(c) more than three (3) months prior to the filing of this Information Disclosure Statement.

Respectfully submitted,

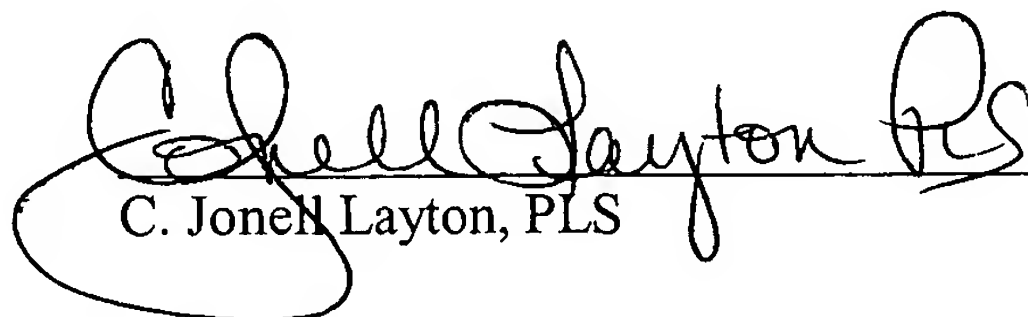
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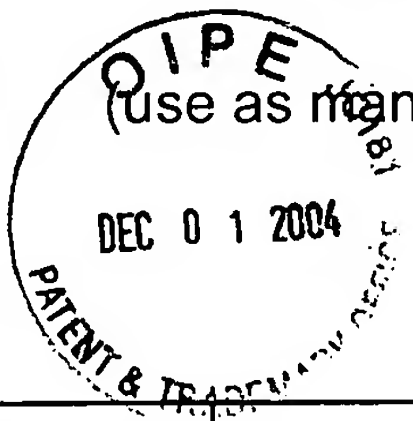
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CERTIFICATE OF MAILING

I certify that this Supplemental Information Disclosure Statement in the application of Cohen et al., Serial No. 10/603,453, filed 06/25/2003 is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450, on this 29th day of November, 2004.


C. Jonell Layton, PLS

RMB/cjl

PTO/SB/08A SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT 				Complete if Known	
				Application Number	10/603,453
				Filing Date	06/25/2003
				Confirmation Number	3271
				First Named Inventor	Jason L. Cohen
				Group Art Unit	2122
				Examiner Name	Not yet assigned
Sheet	1	of	1	Attorney Docket No.	MS#302665.01 (5062)

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY
		Number	Kind Code ² (if known)		
	6	5,794,052		Harding	08/11/1998
	7	6,016,400		Day et al.	01/18/2000
	8	6,080,207		Kroening et al.	06/27/2000
	9	6,247,128	B1	Fisher et al.	06/12/2001
	10	6,262,726	B1	Stedman et al.	07/17/2001
	11	6,385,766	B1	Doran, Jr. et al.	05/07/2002
	12	6,453,413	B1	Chen et al.	09/17/2002
	13	6,512,526	B1	McGlothlin et al.	01/28/2003
	14	6,598,223	B1	Vrhel, Jr. et al.	07/22/2003
	15	6,681,323	B1	Fontanesi et al.	01/20/2004

Examiner Signature		Date Considered	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached or place an "A" here if English language abstract is attached..

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